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**Name:** Chris Dames

**Title:** Assistant Professor

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### Education

2006 PhD Massachusetts Institute of Technology,  
Mechanical Engineering (Adviser: Prof. Gang Chen).

2001 M.S. University of California, Berkeley, Mechanical  
Engineering (Adviser: Prof. Arun Majumdar).

1998 B.S. University of California, Berkeley, Mechanical  
Engineering.

### Professional Experience

Sept. 2006 - present. Assistant Professor, Department of  
Mechanical Engineering, University of California, Riverside.

June 1998 - June 1999. Research Engineer, Solo Energy  
Corp., Alameda, CA.

### Research Interests

Thermal and electrical properties of nanostructures used for  
energy conversion. Modeling and experiments on individual  
nanowires and nanotubes.

### Selected Publications

C. Dames, S. Chen, C. T. Harris, J. Y. Huang, Z. F. Ren, M.  
S. Dresselhaus, and G. Chen, "A modified high-resolution  
TEM for thermoelectric properties measurements of  
nanowires and nanotubes", Proc. of SPIE Optics East, Vol.  
6370, Boston, MA, Oct. 1-4 (2006).

C. Dames, G. Chen, B. Poudel, W. Wang, J. Huang, Z. F.  
Ren, Y. Sun, J. I. Oh, C. Opeil, S.J., and M. J. Naughton,  
"Low dimensional phonon heat capacity of titanium dioxide  
nanotubes," *Appl. Phys. Lett.* **87**, 031901 (2005).

C. Dames and G. Chen, "Theoretical phonon thermal  
conductivity of Si-Ge superlattice nanowires," *J. Appl. Phys.*  
**95**, 682 (2004).

C. Dames and G. Chen, "Thermal conductivity of  
nanostructured thermoelectric materials," in *Thermoelectrics  
Handbook: Macro to Nano*, ed. D. Rowe, CRC Press (2005).

C. Dames and G. Chen, "1, 2, and 3 $\omega$  methods for  
measurement of thermal properties," *Rev. Sci. Instrum.* **76**,  
124902 (2005).